Dual 12-bit ADC; 65 Msps, 80 Msps, 105 Msps or 125 Msps Rev. 05 — 23 April 2010

Preliminary data sheet

### **General description** 1.

The ADC1213D is a dual-channel 12-bit Analog-to-Digital Converter (ADC) optimized for high dynamic performances and low power at sample rates up to 125 Msps. Pipelined architecture and output error correction ensure the ADC1213D is accurate enough to guarantee zero missing codes over the entire operating range. Supplied from a 3 V source for analog and a 1.8 V source for the output driver, it embeds two serial outputs. Each lane is differential and complies with the JESD204A standard. An integrated Serial Peripheral Interface (SPI) allows the user to easily configure the ADC. A set of IC configurations is also available via the binary level control pins taken, which are used at power-up. The device also includes a SPI programmable full-scale to allow flexible input voltage range from 1 V to 2 V (peak-to-peak).

Excellent dynamic performance is maintained from the baseband to input frequencies of 170 MHz or more, making the ADC1213D ideal for use in communications, imaging, and medical applications.

### Features and benefits 2.

- SNR, 70 dBFS; SFDR, 86 dBc
- Sample rate up to 125 Msps
- Clock input divider by 2 for less jitter contribution
- 3 V, 1.8 V single supplies
- Flexible input voltage range: 1 V to 2 V (peak-to-peak)
- Two configurable serial outputs
- INL ± 1 LSB; DNL ± 0.5 LSB
- Pin compatible with the ADC1213D series
- HVQFN56 package

- Input bandwidth, 600 MHz
- Power dissipation, 995 mW at 80 Msps
- SPI register programming
- Duty cycle stabilizer
- High IF capability
- Offset binary, two's complement, gray code
- Power-down mode and Sleep mode
- Compliant with JESD204A serial transmission standard

### **Applications** 3.

- Wireless and wired broadband communications
- Spectral analysis
- Ultrasound equipment

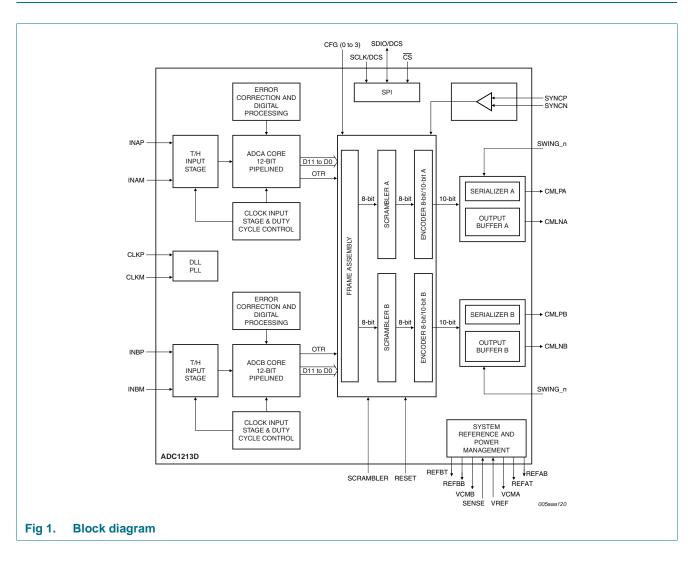
- Portable instrumentation
- Imaging systems
- Software defined radio



### 4. Ordering information

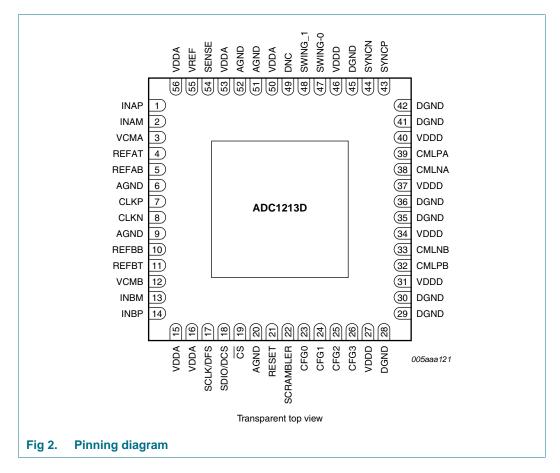
| formation           |   |  |   |  |  |  |  |  |  |
|---------------------|---|--|---|--|--|--|--|--|--|
| Sampling            | Package   |  |   |  |  |  |  |  |  |
| frequency<br>(Msps) | Name  | Description  | Version   |  |  |  |  |  |  |
| 125                 | HVQFN56   | plastic thermal enhanced very thin quad flat package; no leads; 56 terminals; body $8 \times 8 \times 0.85$ mm   | SOT684-7  |  |  |  |  |  |  |
| 105                 | HVQFN56   | plastic thermal enhanced very thin quad flat package; no leads; 56 terminals; body $8 \times 8 \times 0.85$ mm   | SOT684-7  |  |  |  |  |  |  |
| 80                  | HVQFN56   | plastic thermal enhanced very thin quad flat package; no leads; 56 terminals; body 8 $\times$ 8 $\times$ 0.85 mm | SOT684-7  |  |  |  |  |  |  |
| 65                  | HVQFN56   | plastic thermal enhanced very thin quad flat package; no leads; 56 terminals; body $8 \times 8 \times 0.85$ mm   | SOT684-7  |  |  |  |  |  |  |
|                     | Sampling<br>frequency<br>(Msps)<br>125<br>105<br>80 | Sampling<br>frequency<br>(Msps)Package<br>Name125HVQFN56105HVQFN5680HVQFN56                                      | Sampling<br>frequency<br>(Msps)PackageNameDescription125HVQFN56plastic thermal enhanced very thin quad flat package;<br>no leads; 56 terminals; body 8 × 8 × 0.85 mm105HVQFN56plastic thermal enhanced very thin quad flat package;<br>no leads; 56 terminals; body 8 × 8 × 0.85 mm80HVQFN56plastic thermal enhanced very thin quad flat package;<br>no leads; 56 terminals; body 8 × 8 × 0.85 mm65HVQFN56plastic thermal enhanced very thin quad flat package;<br>no leads; 56 terminals; body 8 × 8 × 0.85 mm |  |  |  |  |  |  |

### 5. Block diagram



### 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

| Table 2. | Pin description |                     |                                      |
|----------|-----------------|---------------------|--------------------------------------|
| Symbol   | Pin             | Type <sup>[1]</sup> | Description                          |
| INAP     | 1               | I                   | channel A analog input               |
| INAM     | 2               | I                   | channel A complementary analog input |
| VCMA     | 3               | 0                   | channel A output common voltage      |
| REFAT    | 4               | 0                   | channel A top reference              |
| REFAB    | 5               | 0                   | channel A bottom reference           |
| AGND     | 6               | G                   | analog ground                        |
| CLKP     | 7               | I                   | clock input                          |
| CLKM     | 8               | I                   | complementary clock input            |
| AGND     | 9               | G                   | analog ground                        |
| REFBB    | 10              | 0                   | channel B bottom reference           |
| REFBT    | 11              | 0                   | channel B top reference              |
| VCMB     | 12              | 0                   | channel B output common voltage      |

# **ADC1213D series**

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| Symbol    | Pin | Type [1] | Description   |
|-----------|-----|----------|---|
| INBM      | 13  | I        | channel B complementary analog input                        |
| INBP      | 14  | I        | channel B analog input                                      |
| VDDA      | 15  | Р        | analog power supply 3 V                                     |
| VDDA      | 16  | Р        | analog power supply 3 V                                     |
| SCLK/DCS  | 17  | I        | SPI clock   |
|           |     |          | data format select  |
| SDIO/DCS  | 18  | I/O      | SPI data input/output                                       |
|           |     |          | duty cycle stabilizer                                       |
| CS        | 19  | I        | chip select bar   |
| AGND      | 20  | G        | analog ground   |
| RESET     | 21  | I        | JEDEC digital IP reset                                      |
| SCRAMBLER | 22  | I        | scrambler enable and disable                                |
| CFG0      | 23  | I/O      | see <u>Table 28</u> (input) or OTRA (output) <sup>[2]</sup> |
| CFG1      | 24  | I/O      | see <u>Table 28</u> (input) or OTRB (output) <sup>[2]</sup> |
| CFG2      | 25  | I/O      | see Table 28 (input)  |
| CFG3      | 26  | I/O      | see Table 28 (input)  |
| VDDD      | 27  | Р        | digital power supply 1.8 V                                  |
| DGND      | 28  | G        | digital ground  |
| DGND      | 29  | G        | digital ground  |
| DGND      | 30  | G        | digital ground  |
| VDDD      | 31  | Р        | digital power supply 1.8 V                                  |
| CMLPB     | 32  | 0        | channel B output  |
| CMLNB     | 33  | 0        | channel B complementary output                              |
| VDDD      | 34  | Р        | digital power supply 1.8 V                                  |
| DGND      | 35  | G        | digital ground  |
| DGND      | 36  | G        | digital ground  |
| VDDD      | 37  | Р        | digital power supply 1.8 V                                  |
| CMLNA     | 38  | 0        | channel A complementary output                              |
| CMLPA     | 39  | 0        | channel A output  |
| VDDD      | 40  | Р        | digital power supply 1.8 V                                  |
| DGND      | 41  | G        | digital ground  |
| DGND      | 42  | G        | digital ground  |
| SYNCP     | 43  | I        | synchronization from FPGA                                   |
| SYNCN     | 44  | I        | synchronization from FPGA                                   |
| DGND      | 45  | G        | digital ground  |
| VDDD      | 46  | Р        | digital power supply 1.8 V                                  |
| SWING_0   | 47  | I        | JESD204 serial buffer programmable output swing             |
| SWING_1   | 48  | I        | JESD204 serial buffer programmable output swing             |
| DNC       | 49  | 0        | do not connect  |
| VDDA      | 50  | Р        | analog power supply 3 V                                     |
| AGND      | 51  | G        | analog ground   |

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### Table 2. Pin description ...continued

| Symbol | Pin | Type <sup>[1]</sup> | Description                    |
|--------|-----|---------------------|--------------------------------|
| AGND   | 52  | G                   | analog ground                  |
| VDDA   | 53  | Р                   | analog power supply 3 V        |
| SENSE  | 54  | I                   | reference programming pin      |
| VREF   | 55  | I/O                 | voltage reference input/output |
| VDDA   | 56  | Р                   | analog power supply 3 V        |

[1] P: power supply; G: ground; I: input; O: output; I/O: input/output.

[2] OTRA stands for "OuT of Range" A. OTRB stands for "OuT of Range" B

### 7. Limiting values

### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                 | Conditions                        | Min             | Max         | Unit |
|------------------|---------------------------|-----------------------------------|-----------------|-------------|------|
| V <sub>DDA</sub> | analog supply voltage     |                                   | <u>[1]</u> –0.4 | +4.6        | V    |
| V <sub>DDD</sub> | digital supply voltage    |                                   | 2 -0.4          | +2.5        | V    |
| $\Delta V_{CC}$  | supply voltage difference | $V_{\text{DDA}} - V_{\text{DDD}}$ | <tbd></tbd>     | <tbd></tbd> | V    |
| T <sub>stg</sub> | storage temperature       |                                   | -55             | +125        | °C   |
| T <sub>amb</sub> | ambient temperature       |                                   | -40             | +85         | °C   |
| Tj               | junction temperature      |                                   | -               | 125         | °C   |

[1] The supply voltage V<sub>DDA</sub> may have any value between -0.5 V and +7.0 V provided that the supply voltage differences  $\Delta V_{CC}$  are respected.

[2] The supply voltage V<sub>DDD</sub> may have any value between -0.5 V and +5.0 V provided that the supply voltage differences  $\Delta V_{CC}$  are respected.

### 8. Thermal characteristics

| Table 4.             | Thermal characteristics                     |            |                  |      |
|----------------------|---|------------|------------------|------|
| Symbol               | Parameter                                   | Conditions | Тур              | Unit |
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient |            | [ <u>1]</u> 17.8 | K/W  |
| R <sub>th(j-c)</sub> | thermal resistance from junction to case    |            | <u>[1]</u> 6.8   | K/W  |

[1] Value for six layers board in still air with a minimum of 25 thermal vias.

### 9. Static characteristics

| Table 5.         | Characteristics <sup>[1]</sup> |  |      |     |      |      |
|------------------|--------------------------------|--|------|-----|------|------|
| Symbol           | Parameter                      | Conditions   | Min  | Тур | Max  | Unit |
| Supplies         |                                |  |      |     |      |      |
| V <sub>DDA</sub> | analog supply voltage          |  | 2.85 | 3.0 | 3.4  | V    |
| V <sub>DDD</sub> | digital supply voltage         |  | 1.65 | 1.8 | 1.95 | V    |
| I <sub>DDA</sub> | analog supply current          | f <sub>clk</sub> = 125 Msps;<br>f <sub>i</sub> =70 MHz | -    | 343 | -    | mA   |

# **ADC1213D series**

ADC1213D series

| Symbol                 | Parameter                        | Conditions  | Min            | Тур           | Max              | Unit |
|------------------------|----------------------------------|---|----------------|---------------|------------------|------|
| I <sub>DDD</sub>       | digital supply current           | f <sub>clk</sub> = 125 Msps;<br>f <sub>i</sub> = 70 MHz | -              | 150           | -                | mA   |
| P <sub>tot</sub>       | total power dissipation          | f <sub>clk</sub> = 125 Msps                             | -              | 1270          | -                | mW   |
|                        |                                  | f <sub>clk</sub> = 105 Msps                             | -              | 1150          | -                | mW   |
|                        |                                  | f <sub>clk</sub> = 80 Msps                              | -              | 995           | -                | mW   |
|                        |                                  | f <sub>clk</sub> = 65 Msps                              | -              | 885           | -                | mW   |
| Р                      | power dissipation                | power-down mode   | -              | 30            | -                | mW   |
|                        |                                  | standby mode  | -              | 200           | -                | mW   |
| Digital inpu           | uts                              |   |                |               |                  |      |
| <b>Clock inpu</b>      | ts: pins CLKP and CLKM,          | AC coupled  |                |               |                  |      |
| LVPECL                 |                                  |   |                |               |                  |      |
| V <sub>i(clk)dif</sub> | differential clock input voltage | peak-to-peak  | -              | ±0.8          | -                | V    |
| LVDS                   |                                  |   |                |               |                  |      |
| V <sub>i(clk)dif</sub> | differential clock input voltage | peak-to-peak  | -              | ±0.4          | -                | V    |
| SINE wave              |                                  |   |                |               |                  |      |
| V <sub>i(clk)dif</sub> | differential clock input voltage | peak-to-peak  | ±0.8           | ±1.5          | -                | V    |
| LVCMOS m               | node                             |   |                |               |                  |      |
| V <sub>IL</sub>        | LOW-level input voltage          |   | -              | -             | $0.3V_{DDA}$     | V    |
| V <sub>IH</sub>        | HIGH-level input voltage         | ;   | $0.7V_{DDA}$   | -             | -                | V    |
| Logic inpu             | ts, Power-down: pins CFG         | 0 to CFG3, SCRAMBLER                                    | , SWING_0, and | SWING_1       |                  |      |
| V <sub>IL</sub>        | LOW-level input voltage          |   | -              | 0             | -                | V    |
| V <sub>IH</sub>        | HIGH-level input voltage         | )   | -              | $0.66V_{DDD}$ | -                | V    |
| IIL                    | LOW-level input current          |   | -6             | -             | +6               | μA   |
| I <sub>IH</sub>        | HIGH-level input current         |   | -30            | -             | +30              | μΑ   |
| SPI: pins C            | S, SDIO/DCS, and SCLK/D          | CS  |                |               |                  |      |
| V <sub>IL</sub>        | LOW-level input voltage          |   | 0              | -             | $0.3V_{DDA}$     | V    |
| V <sub>IH</sub>        | HIGH-level input voltage         | )   | $0.7V_{DDA}$   | -             | V <sub>DDA</sub> | V    |
| I <sub>IL</sub>        | LOW-level input current          |   | -10            | -             | +10              | μA   |
| I <sub>IH</sub>        | HIGH-level input current         |   | -50            | -             | +50              | μΑ   |
| CI                     | input capacitance                |   | -              | 4             | -                | pF   |

### Table 5. Characteristics<sup>[1]</sup> ...continue

# **ADC1213D series**

ADC1213D series

| Table 5.            | Characteristics <sup>[1]</sup> contin   | ued                |     |  |   |      |
|---------------------|---|--------------------|-----|--|---|------|
| Symbol              | Parameter   | Conditions         | Min | Тур  | Мах   | Unit |
| Analog in           | puts: pins INAP, INAM, INE  | 3P, and INBM       |     |  |   |      |
| lı                  | input current   | track mode         | -5  | -  | +5  | μA   |
| RI                  | input resistance  | track mode         | -   | 15   | -   | Ω    |
| CI                  | input capacitance   | track mode         | -   | 5  | -   | pF   |
| V <sub>I(cm)</sub>  | common-mode input<br>voltage  | track mode         | 0.9 | 1.5  | 2   | V    |
| B <sub>i</sub>      | input bandwidth   |                    | -   | 600  | -   | MHz  |
| V <sub>I(dif)</sub> | differential input voltag   | e peak-to-peak     | 1   | -  | 2   | V    |
| Voltage c           | ontrolled regulator output:   | pins VCMA and VCMB |     |  |   |      |
| V <sub>O(cm)</sub>  | common-mode output<br>voltage   |                    | -   | $0.5V_{DDA}$                                     | -   | V    |
| I <sub>O(cm)</sub>  | common-mode output<br>current   |                    | -   | <tbd></tbd>                                      | -   | μΑ   |
| Reference           | e voltage input/output: pin   | VREF               |     |  |   |      |
| V <sub>VREF</sub>   | voltage on pin VREF   | output             | 0.5 | -  | 1   | V    |
|                     |   | input              | 0.5 | -  | 1   | V    |
| Reference           | e mode selection: pin SEN   | SE                 |     |  |   |      |
| V <sub>SENSE</sub>  | voltage on pin SENSE  |                    | -   | pin AGND;<br>V <sub>VREF</sub> ; V <sub>DD</sub> | -<br>A  | V    |
| Data outp           | outs: CMLPA, CMLNA  |                    |     |  |   |      |
| Output lev          | vels, V <sub>DDD</sub> = 1.8 V; SWING_  | SEL[2:0] = 000     |     |  |   |      |
| / <sub>OL</sub>     | LOW-level output  | DC coupled; output | -   | 1.5  | -   | V    |
|                     | voltage   | AC coupled         | -   | 1.65   | -   | V    |
| V <sub>OH</sub>     | $\frac{\text{LOW-level output}}{\text{voltage}} = \frac{1.8 \text{ V; SWING\_SEL[2:0]} = 000}{\text{DC coupled; output}}$ | DC coupled; output | -   | 1.8  | -   | V    |
|                     | voltage   | AC coupled         | -   | 1.35   | -   | V    |
| Output lev          | vels, V <sub>DDD</sub> = 1.8 V; SWING_S   | SEL[2:0] = 001     |     |  |   |      |
| V <sub>OL</sub>     | LOW-level output  | DC coupled; output | -   | 1.45   | -   | V    |
|                     | voltage   | AC coupled         | -   | 1.625  | -   | V    |
| V <sub>OH</sub>     | HIGH-level output   | DC coupled; output | -   | 1.8  | +5<br>-<br>-<br>2<br>-<br>2<br>-<br>2<br>-<br>-<br>2<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | V    |
|                     | voltage   | AC coupled         | -   | 1.275  | -   | V    |
| Output lev          | vels, V <sub>DDD</sub> = 1.8 V; SWING_S   | SEL[2:0] = 010     |     |  |   |      |
| V <sub>OL</sub>     | LOW-level output  | DC coupled; output | -   | 1.4  | -   | V    |
|                     | voltage   | AC coupled         | -   | 1.6  | -   | V    |
| V <sub>OH</sub>     | HIGH-level output   | DC coupled; output | -   | 1.8  | -   | V    |
|                     | voltage   | AC coupled         | -   | 1.2  | -   | V    |
| Output lev          | vels, V <sub>DDD</sub> = 1.8 V; SWING_  | SEL[2:0] = 011     |     |  |   |      |
| V <sub>OL</sub>     | LOW-level output  | DC coupled; output | -   | 1.35   | -   | V    |
|                     | voltage   | AC coupled         | -   | 1.575  | -   | V    |
| V <sub>OH</sub>     | HIGH-level output   | DC coupled; output | -   | 1.8  | -   | V    |
|                     | voltage   | AC coupled         | -   | 1.125  | -   | V    |

# **ADC1213D series**

ADC1213D series

| Symbol              | Parameter                               | Conditions                     | Min   | Тур         | Max   | Unit |
|---------------------|---|--------------------------------|-------|-------------|-------|------|
| Output leve         | els, V <sub>DDD</sub> = 1.8 V; SWING_SE | L[2:0] = 100                   |       |             |       |      |
| V <sub>OL</sub>     | LOW-level output                        | DC coupled; output             | -     | 1.3         | -     | V    |
|                     | voltage                                 | AC coupled                     | -     | 1.55        | -     | V    |
| V <sub>OH</sub>     | HIGH-level output                       | DC coupled; output             | -     | 1.8         | -     | V    |
|                     | voltage                                 | AC coupled                     | -     | 1.05        | -     | V    |
| Serial con          | figuration: SYNCCP, SYNCC               | N                              |       |             |       |      |
| V <sub>IL</sub>     | LOW-level input voltage                 | differential; input            | -     | 0.95        | -     | V    |
| V <sub>IH</sub>     | High-level input voltage                | differential; input            | -     | 1.47        | -     | V    |
| Accuracy            |   |                                |       |             |       |      |
| INL                 | integral non-linearity                  |                                | -5    | ±1          | +5    | LSB  |
| DNL                 | differential non-linearity              | no missing codes<br>guaranteed | -0.95 | ±0.5        | +0.95 | LSB  |
| Eoffset             | offset error                            |                                | -     | ±2          | -     | mV   |
| E <sub>G</sub>      | gain error                              | full-scale                     | -     | $\pm 0.5$   | -     | %    |
| M <sub>G(CTC)</sub> | channel-to-channel gain<br>matching     |                                | -     | <tbd></tbd> | -     | %    |
| Supply              |   |                                |       |             |       |      |
| PSRR                | power supply rejection ratio            | 100 mV (p-p) on VDDA           | -     | 35          | -     | dBc  |

[1] Typical values measured at  $V_{DDA} = 3 \text{ V}$ ,  $V_{DDD} = 1.8 \text{ V}$ ,  $T_{amb} = 25 \text{ °C}$ . Minimum and maximum values are across the full temperature range  $T_{amb} = -40 \text{ °C}$  to +85 °C at  $V_{DDA} = 3 \text{ V}$ ,  $V_{DDD} = 1.8 \text{ V}$ ;  $V_1$  (INAP, INBP) –  $V_1$  (INAM, INBM) = -1 dBFS; internal reference mode; 100  $\Omega$  differential applied to serial outputs; unless otherwise specified.

# ADC1213D series

ADC1213D series

# **10. Dynamic characteristics** 10. Dy Table 6.

Characteristics<sup>[1]</sup>

| Symbol        | Parameter                 | Conditions               | ADC | 1213D06 | 65  | ADC | 1213D08 | 30  | ADC | 1213D1 | 05  | ADC | 1213D12 | 25  | Unit |
|---------------|---------------------------|--------------------------|-----|---------|-----|-----|---------|-----|-----|--------|-----|-----|---------|-----|------|
|               |                           |                          | Min | Тур     | Max | Min | Тур     | Max | Min | Тур    | Max | Min | Тур     | Max |      |
| Analog s      | ignal processing          |                          |     |         |     |     | 1       |     | •   | •      | •   |     |         |     |      |
| $\alpha_{2H}$ | second harmonic level     | $f_i = 3 MHz$            | -   | 87      | -   | -   | 87      | -   | -   | 86     | -   | -   | 88      | -   | dBc  |
|               |                           | $f_i = 30 \text{ MHz}$   | -   | 86      | -   | -   | 86      | -   | -   | 86     | -   | -   | 87      | -   | dBc  |
|               |                           | $f_i = 70 \text{ MHz}$   | -   | 85      | -   | -   | 85      | -   | -   | 84     | -   | -   | 85      | -   | dBc  |
|               |                           | $f_i = 170 \text{ MHz}$  | -   | 82      | -   | -   | 82      | -   | -   | 81     | -   | -   | 83      | -   | dBc  |
| $\alpha_{3H}$ | third harmonic level      | $f_i = 3 MHz$            | -   | 86      | -   | -   | 86      | -   | -   | 85     | -   | -   | 87      | -   | dBc  |
|               |                           | $f_i = 30 \text{ MHz}$   | -   | 85      | -   | -   | 85      | -   | -   | 85     | -   | -   | 86      | -   | dBc  |
|               |                           | $f_i = 70 \text{ MHz}$   | -   | 84      | -   | -   | 84      | -   | -   | 83     | -   | -   | 84      | -   | dBo  |
|               |                           | $f_i = 170 \text{ MHz}$  | -   | 81      | -   | -   | 81      | -   | -   | 80     | -   | -   | 82      | -   | dBo  |
| THD           | total harmonic distortion | $f_i = 3 MHz$            | -   | 85      | -   | -   | 85      | -   | -   | 84     | -   | -   | 86      | -   | dBc  |
|               |                           | $f_i = 30 \text{ MHz}$   | -   | 84      | -   | -   | 84      | -   | -   | 84     | -   | -   | 85      | -   | dBo  |
|               |                           | $f_i = 70 \text{ MHz}$   | -   | 83      | -   | -   | 83      | -   | -   | 82     | -   | -   | 83      | -   | dBo  |
|               |                           | f <sub>i</sub> = 170 MHz | -   | 80      | -   | -   | 80      | -   | -   | 79     | -   | -   | 81      | -   | dBo  |
| ENOB          | effective number of bits  | $f_i = 3 MHz$            | -   | 11.3    | -   | -   | 11.3    | -   | -   | 11.3   | -   | -   | 11.3    | -   | bits |
|               |                           | $f_i = 30 \text{ MHz}$   | -   | 11.3    | -   | -   | 11.3    | -   | -   | 11.3   | -   | -   | 11.2    | -   | bits |
|               |                           | $f_i = 70 \text{ MHz}$   | -   | 11.2    | -   | -   | 11.2    | -   | -   | 11.2   | -   | -   | 11.2    | -   | bits |
|               |                           | f <sub>i</sub> = 170 MHz | -   | 11.1    | -   | -   | 11.1    | -   | -   | 11.1   | -   | -   | 11.1    | -   | bits |
| SNR           | signal-to-noise ratio     | $f_i = 3 MHz$            | -   | 70.0    | -   | -   | 69.9    | -   | -   | 69.8   | -   | -   | 69.6    | -   | dBF  |
|               |                           | $f_i = 30 \text{ MHz}$   | -   | 69.5    | -   | -   | 69.5    | -   | -   | 69.5   | -   | -   | 69.4    | -   | dBF  |
|               |                           | $f_i = 70 \text{ MHz}$   | -   | 69.2    | -   | -   | 69.2    | -   | -   | 69.1   | -   | -   | 69.0    | -   | dBF  |
|               |                           | f <sub>i</sub> = 170 MHz | -   | 68.8    | -   | -   | 68.8    | -   | -   | 68.7   | -   | -   | 68.6    | -   | dBF  |
| SFDR          | spurious-free dynamic     | $f_i = 3 MHz$            | -   | 86      | -   | -   | 86      | -   | -   | 85     | -   | -   | 87      | -   | dBc  |
|               | range                     | $f_i = 30 \text{ MHz}$   | -   | 85      | -   | -   | 85      | -   | -   | 85     | -   | -   | 86      | -   | dBc  |
|               |                           | $f_i = 70 \text{ MHz}$   | -   | 84      | -   | -   | 84      | -   | -   | 83     | -   | -   | 84      | -   | dBc  |
|               |                           | f <sub>i</sub> = 170 MHz | -   | 81      | -   | -   | 81      | -   | -   | 80     | -   | -   | 82      | -   | dBc  |

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### Characteristics<sup>[1]</sup> ...continued Table 6.

| Sym             | Symbol                         | Parameter                     | Conditions               | ADC | ADC1213D065 |     | ADC1213D080 |     |     | ADC1213D105 |     |     | ADC1213D125 |     |     | Unit |
|-----------------|--------------------------------|-------------------------------|--------------------------|-----|-------------|-----|-------------|-----|-----|-------------|-----|-----|-------------|-----|-----|------|
|                 |                                |                               |                          | Min | Тур         | Max | Min         | Тур | Max | Min         | Тур | Max | Min         | Тур | Max |      |
| IMD             | IMD intermodulation distortion | f <sub>i</sub> = 3 MHz        | -                        | 89  | -           | -   | 89          | -   | -   | 88          | -   | -   | 89          | -   | dBc |      |
|                 |                                |                               | $f_i = 30 \text{ MHz}$   | -   | 88          | -   | -           | 88  | -   | -           | 88  | -   | -           | 88  | -   | dBo  |
|                 |                                |                               | f <sub>i</sub> = 70 MHz  | -   | 87          | -   | -           | 87  | -   | -           | 86  | -   | -           | 86  | -   | dBc  |
|                 |                                |                               | f <sub>i</sub> = 170 MHz | -   | 84          | -   | -           | 85  | -   | -           | 83  | -   | -           | 84  | -   | dBc  |
| $\alpha_{ct(c}$ | ch)                            | crosstalk between<br>channels | $f_i = 70 \text{ MHz}$   | -   | 100         | -   | -           | 100 | -   | -           | 100 | -   | -           | 100 | -   | dBo  |

[1] Typical values measured at  $V_{DDA} = 3 \text{ V}, V_{DDD} = 1.8 \text{ V}, T_{amb} = 25 \text{ °C}$ . Minimum and maximum values are across the full temperature range  $T_{amb} = -40 \text{ °C}$  to +85 °C at  $V_{DDA} = 3 \text{ V}, V_{DDD} = 1.8 \text{ V}; V_{I}$  (INAP, INBP) –  $V_{I}$  (INAM, INBM) = -1 dBFS; internal reference mode; 100  $\Omega$  differential applied to serial outputs; unless otherwise specified.

# 11. Clock and digital output timing ADC1213D\_SER\_

Characteristics<sup>[1]</sup> Table 7.

| Symbol                 | Parameter             | Conditions         | ADC1 | 213D065     |     | ADC1 | 213D080     | )   | ADC1 | 213D105     |     | ADC1 | 213D125     |     | Unit |
|------------------------|-----------------------|--------------------|------|-------------|-----|------|-------------|-----|------|-------------|-----|------|-------------|-----|------|
|                        |                       |                    | Min  | Тур         | Мах | Min  | Тур         | Мах | Min  | Тур         | Max | Min  | Тур         | Max |      |
| Clock tin              | ning input: pins CLKF | P and CLKM         |      |             |     |      |             |     |      |             |     |      |             |     |      |
| f <sub>clk</sub>       | clock frequency       |                    | 20   | -           | 65  | 60   | -           | 80  | 75   | -           | 105 | 100  | -           | 125 | Msps |
| t <sub>lat(data)</sub> | data latency time     | clock cycles       | 307  | -           | 850 | 250  | -           | 283 | 190  | -           | 226 | 160  | -           | 170 | ns   |
| δ <sub>clk</sub>       | clock duty cycle      | DCS_EN = 1:<br>en  | 30   | 50          | 70  | 30   | 50          | 70  | 30   | 50          | 70  | 30   | 50          | 70  | %    |
|                        |                       | DCS_EN = 0:<br>dis | 45   | 50          | 55  | 45   | 50          | 55  | 45   | 50          | 55  | 45   | 50          | 55  | %    |
| t <sub>d(s)</sub>      | sampling delay time   |                    | -    | 0.8         | -   | -    | 0.8         | -   | -    | 0.8         | -   | -    | 0.8         | -   | ns   |
| t <sub>wake</sub>      | wake-up time          |                    | -    | <tbd></tbd> | -   | ns   |

Typical values measured at  $V_{DDA} = 3 \text{ V}, V_{DDD} = 1.8 \text{ V}, T_{amb} = 25 \text{ °C}$ . Minimum and maximum values are across the full temperature range  $T_{amb} = -40 \text{ °C}$  to +85 °C at  $V_{DDA} = 3 \text{ V}, V_{DDD} = 1.8 \text{ V}; V_1$  (INAP, INBP) –  $V_1$  (INAM, INBM) = -1 dBFS; internal reference mode; 100 W differential applied to serial outputs; unless otherwise specified. [1]

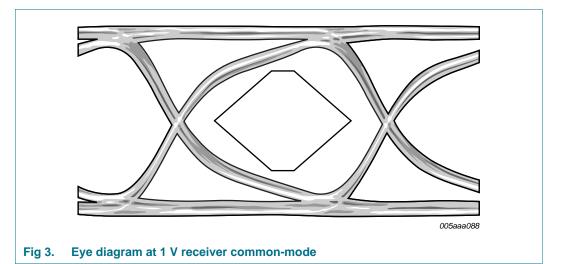
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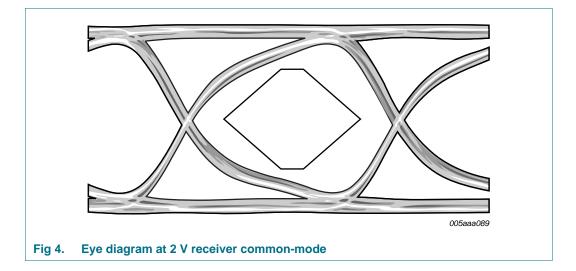
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### 12. Serial output timings

The eye diagram of the serial output is shown in <u>Figure 3</u> and <u>Figure 4</u>. Test conditions are:

- 3.125 Gbps data rate
- T<sub>amb</sub> = 25 °C
- DC coupling with two different receiver common-mode voltages

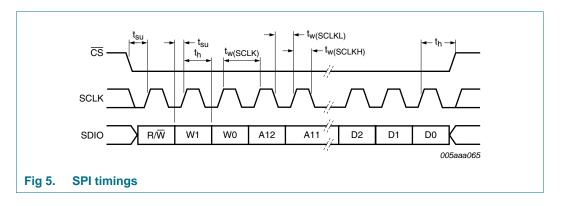




### 13. SPI timing

| Table 8.              | Characteristics            |               |     |     |     |      |
|-----------------------|----------------------------|---------------|-----|-----|-----|------|
| Symbol                | Parameter                  | Conditions    | Min | Тур | Max | Unit |
| Serial Per            | ripheral Interface timings |               |     |     |     |      |
| t <sub>w(SCLK)</sub>  | SCLK pulse width           |               | 40  | -   | -   | ns   |
| t <sub>w(SCLKH)</sub> | SCLK HIGH pulse width      |               | 16  | -   | -   | ns   |
| t <sub>w(SCLKL)</sub> | SCLK LOW pulse width       |               | 16  | -   | -   | ns   |
| t <sub>su</sub>       | set-up time                | data to SCLKH | 5   | -   | -   | ns   |
|                       |                            | CS to SCLKH   | 5   | -   | -   | ns   |
| t <sub>h</sub>        | hold time                  | data to SCLKH | 2   | -   | -   | ns   |
|                       |                            | CS to SCLKH   | 2   | -   | -   | ns   |
| f <sub>clk(max)</sub> | maximum clock frequency    |               | -   | -   | 25  | MHz  |

[1] Typical values measured at  $V_{DDA} = 3 \text{ V}$ ,  $V_{DDD} = 1.8 \text{ V}$ ,  $T_{amb} = 25 \text{ °C}$ . Minimum and maximum values are across the full temperature range  $T_{amb} = -40 \text{ °C}$  to +85 °C at  $V_{DDA} = 3 \text{ V}$ ,  $V_{DDD} = 1.8 \text{ V}$ ;  $V_I$  (INAP, INBP) –  $V_I$  (INAM,INBM) = -1 dBFS; internal reference mode; 100  $\Omega$  differential applied to serial outputs; unless otherwise specified.



### 14. Application information

### 14.1 Analog inputs

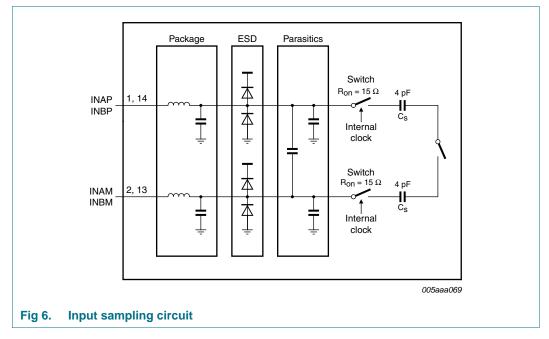
### 14.1.1 Input stage description

The analog input of the ADC1213D supports differential or single-ended input drive. Optimal performance is achieved using differential inputs with the common-mode input voltage ( $V_{l(cm)}$ ) on pins INxP and INxM set to 0.5V<sub>DDA</sub>.

The full scale analog input voltage range is configurable between  $\pm$  1 V (p-p) and  $\pm$  2 V (p-p) via a programmable internal reference (see <u>Section 14.2</u> and <u>Table 21</u> for further details).

<u>Figure 6</u> shows the equivalent circuit of the sample and hold input stage, including ElectroStatic Discharge (ESD) protection and circuit and package parasitics.

ADC1213D series

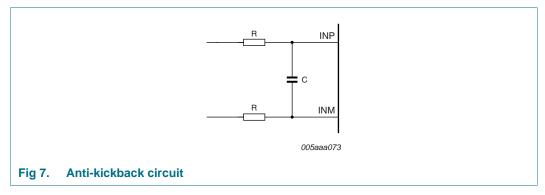


The sample phase occurs when the internal clock (derived from the clock signal on pin CLKP/CLKM) is HIGH. The voltage is then held on the sampling capacitors. When the clock signal goes LOW, the stage enters the hold phase and the voltage information is transmitted to the ADC core.

### 14.1.2 Anti-kickback circuitry

Anti-kickback circuitry (RC filter in Figure 7) is needed to counteract the effects of a charge injection generated by the sampling capacitance.

The RC filter is also used to filter noise from the signal before it reaches the sampling stage. The value of the capacitor should be chosen to maximize noise attenuation without degrading the settling time excessively.

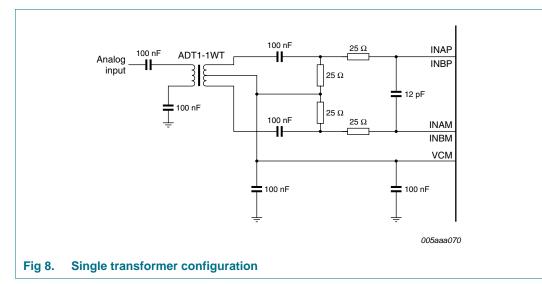


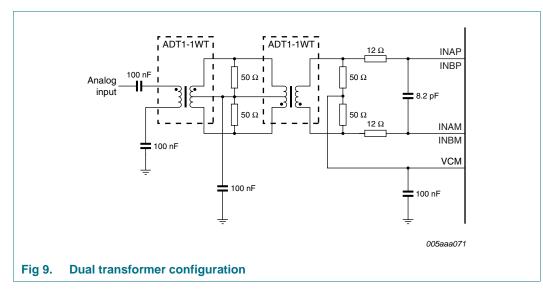
The component values are determined by the input frequency and should be selected so as not to affect the input bandwidth.

| Table 9. RC coupling ver | 9. RC coupling versus input frequency - typical values |       |  |  |  |  |
|--------------------------|--|-------|--|--|--|--|
| Input frequency          | R  | С     |  |  |  |  |
| 3 MHz                    | 25 Ω   | 12 pF |  |  |  |  |
| 70 MHz                   | 12 Ω   | 8 pF  |  |  |  |  |
| 170 MHz                  | 12 Ω   | 8 pF  |  |  |  |  |

### 14.1.3 Transformer

The configuration of the transformer circuit is determined by the input frequency. The configuration shown in Figure 8 would be suitable for a baseband application.





The configuration shown in Figure 9 is recommended for high frequency applications. In both cases, the choice of transformer will be a compromise between cost and performance.

### 14.2 System reference and power management

### 14.2.1 Internal/external reference

The ADC1213D has a stable and accurate built-in internal reference voltage to adjust the ADC full-scale. This reference voltage can be set internally via SPI or with pin VREF an SENSE (see Figure 11, Figure 12, Figure 13 and Figure 14), in 1 dB steps between 0 dB and –6 dB, via SPI control bits INTREF[2:0] (when bit INTREF\_EN = 1; see Table 21). The equivalent reference circuit is shown in Figure 10. External reference is also possible by providing a voltage on pin VREF as described in Figure 13.

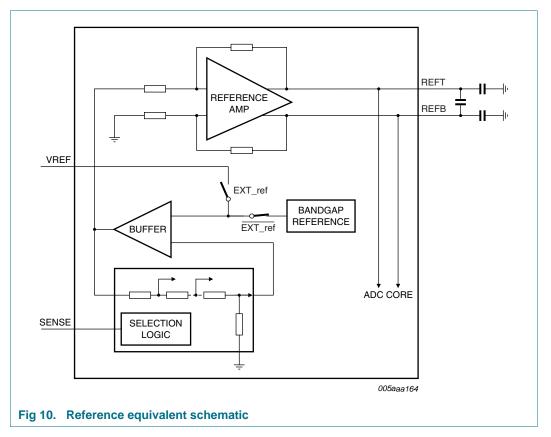


Table 10 shows how to choose between the different internal/external modes:

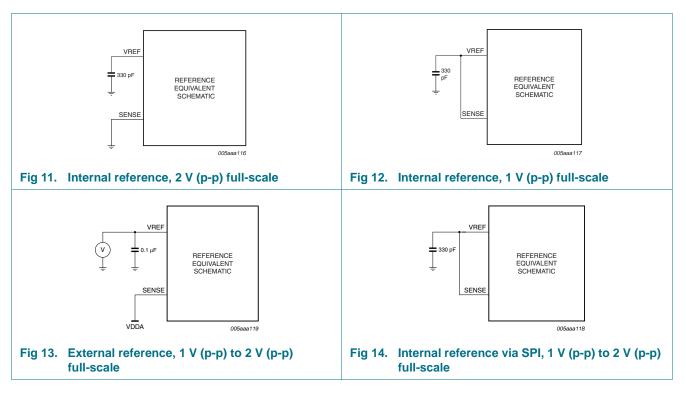
### Table 10.Reference modes

| Mode                                       | SPI bit, "Internal reference" | SENSE pin                        | VREF pin                           | Full Scale,<br>V (p-p) |
|--|-------------------------------|----------------------------------|------------------------------------|------------------------|
| Internal ( <u>Figure 11</u> )              | 0                             | GND                              | 330 pF capacitor to GND            |                        |
| Internal (Figure 12)                       | 0                             | VREF pin = SE<br>330 pF capacite |                                    | 1                      |
| External (Figure 13)                       | 0                             | V <sub>DDA</sub>                 | External voltage from 0.5 V to 1 V | 1 to 2                 |
| Internal, SPI mode<br>( <u>Figure 14</u> ) | 1                             | VREF pin = SE<br>330 pF capacito |                                    | 1 to 2                 |

Figure 11 to Figure 14 indicate how to connect the SENSE and VREF pins.

# **ADC1213D series**

ADC1213D series



### 14.2.2 Reference gain control

The reference gain is programmable between 0 dB to -6 dB in steps of 1 dB via the SPI (see <u>Table 21</u>). The corresponding full scale input voltage range varies between 2 V (p-p) and 1 V (p-p), as shown in <u>Table 11</u>:

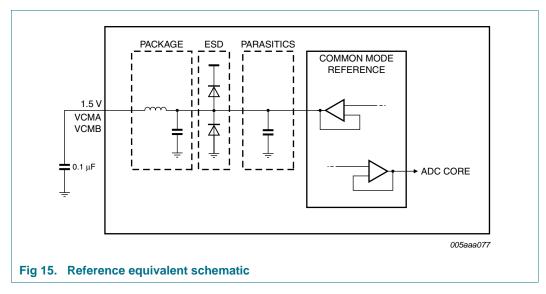
| INTREF[2:0] | Level    | Full Scale, V (p-p) |
|-------------|----------|---------------------|
| 000         | 0 dB     | 2                   |
| 001         | -1 dB    | 1.78                |
| 010         | –2 dB    | 1.59                |
| 011         | –3 dB    | 1.42                |
| 100         | -4 dB    | 1.26                |
| 101         | –5 dB    | 1.12                |
| 110         | -6 dB    | 1                   |
| 111         | not used | x                   |

### Table 11. Reference SPI gain control

### 14.2.3 Common-mode output voltage (VI(cm))

An 0.1  $\mu$ F filter capacitor should be connected between on the one hand the pins VCMA and VCMB and on the other hand ground to ensure a low-noise common-mode output voltage. When AC-coupled, these pins can be used to set the common-mode reference for the analog inputs, for instance via a transformer middle point.

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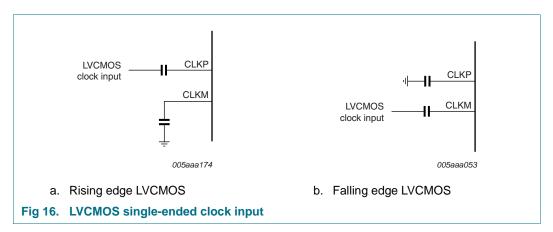
### 14.2.4 Biasing

The common-mode output voltage,  $V_{O(cm)}$ , should be set externally to 1.5 V (typical). The common-mode input voltage,  $V_{I(cm)}$ , at the inputs to the sample and hold stage (pins INAM, INBM, INAP, and INBP) must be between 0.9 V and 2 V for optimal performance.

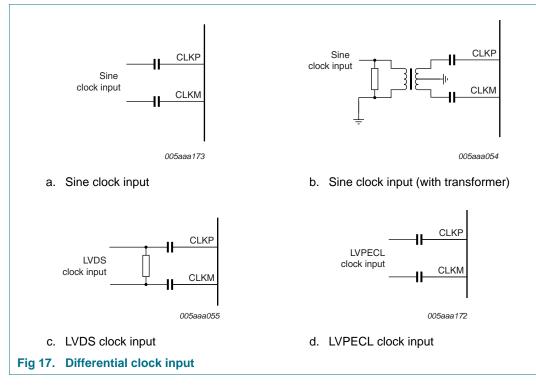
### 14.3 Clock input

### 14.3.1 Drive modes

The ADC1213D can be driven differentially (SINE, LVPECL or LVDS) with little or no influence on dynamic performances. It can also be driven by a single-ended LVCMOS signal connected to pin CLKP (CLKM should be connected to ground via a capacitor).

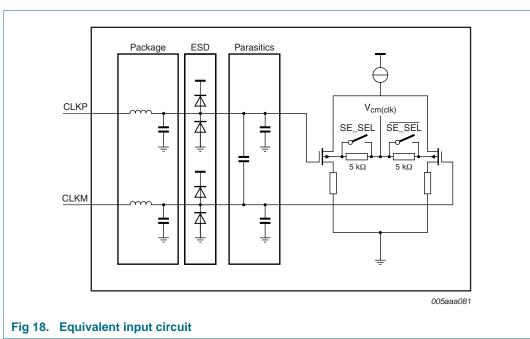


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### 14.3.2 Equivalent input circuit

The equivalent circuit of the input clock buffer is shown in Figure 18. The common-mode voltage of the differential input stage is set via internal resistors of 5 k $\Omega$  resistors.



Single-ended or differential clock inputs can be selected via the SPI (see <u>Table 20</u>). If single-ended is selected, the input pin (CLKM or CLKP) is selected via control bit

SE\_SEL.

If single-ended is implemented without setting SE\_SEL accordingly, the unused pin should be connected to ground via a capacitor.

### 14.3.3 Clock input divider

The ADC1413D contains an input clock divider that divides the incoming clock by a factor of 2 (when bit CLKDIV = 1; see <u>Table 20</u>). This feature allows the user to deliver a higher clock frequency with better jitter performance, leading to a better SNR result once acquisition has been performed.

### 14.3.4 Duty cycle stabilizer

The duty cycle stabilizer can improve the overall performances of the ADC by compensating the input clock signal duty cycle. When the duty cycle stabilizer is active (bit DCS\_EN = 1; see Table 20), the circuit can handle signals with duty cycles of between 30 % and 70 % (typical). When the duty cycle stabilizer is disabled (DCS\_EN = 0), the input clock signal should have a duty cycle of between 45 % and 55 %.

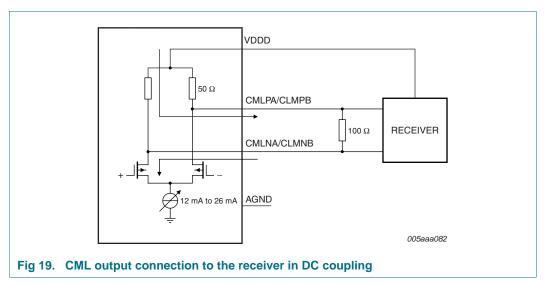
### Table 12. Duty cycle stabilizer

| DCS_enable SPI | Description                   |
|----------------|-------------------------------|
| 0              | duty cycle stabilizer disable |
| 1              | duty cycle stabilizer enable  |

### 14.4 Digital outputs

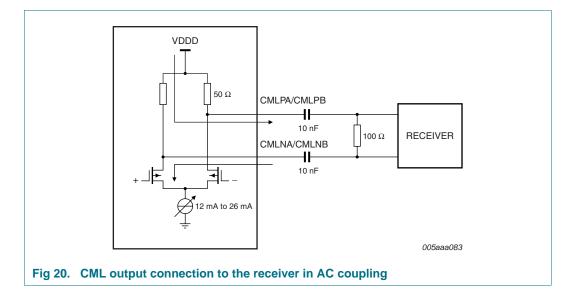
### 14.4.1 Serial output equivalent circuit

The JESD204A standard specify that in case of connecting the receiver and the transmitter in DC coupling, both of them need to be provided by the same supply.



The output should be terminated when 100  $\Omega$  (typical) has been reached at the receiver side.

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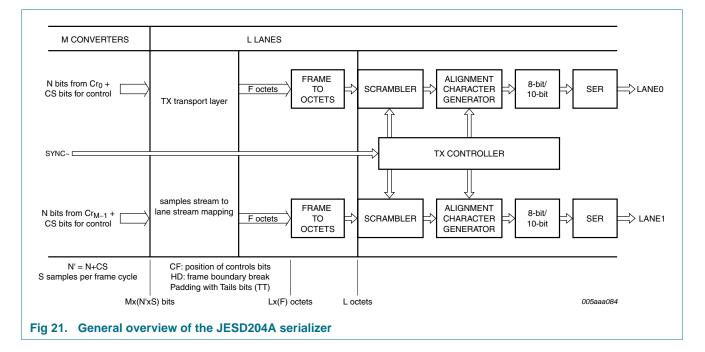


### 14.5 JESD204A serializer

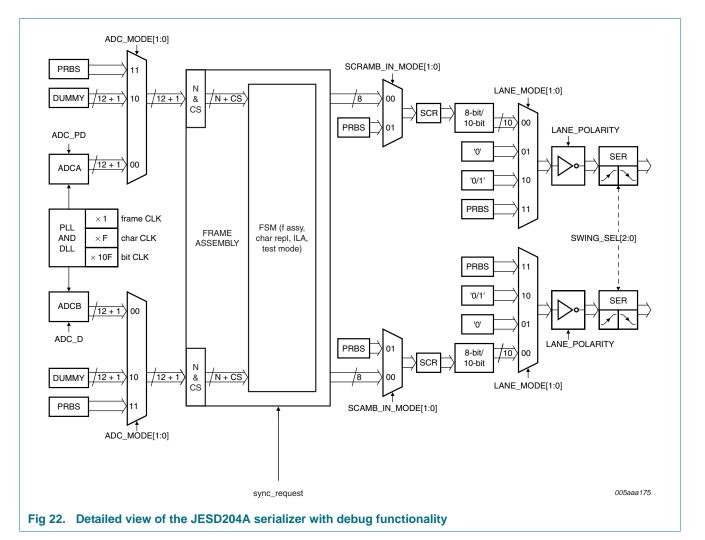
### 14.5.1 Digital JESD204A formatter

The block placed after the ADC cores is used to implement all functionalities of the JESD204A standard. This ensures signal integrity and guarantees the clock and the data recovery at the receiver side.

The block is highly parameterized and can be configured in various ways depending on the sampling frequency and the number of lanes used.



ADC1213D series



### 14.5.2 ADC core output codes versus input voltage

Table 13 shows the data output codes for a given analog input voltage.

| Table 13. | Output cod | des versus | input v | oltage |
|-----------|------------|------------|---------|--------|
|-----------|------------|------------|---------|--------|

| INP-INM (V) | Offset binary   | Two's complement   | OTR                                   |
|-------------|---|--------------------|---------------------------------------|
| < -1        | 0000 0000 0000  | 1000 0000 0000     | 1                                     |
| -1.0000000  | 0000 0000 0000  | 1000 0000 0000     | 0                                     |
| -0.9995117  | 0000 0000 0001  | 1000 0000 0001     | 0                                     |
| -0.9990234  | 0000 0000 0010  | 1000 0000 0010     | 0                                     |
| -0.9985352  | 0000 0000 0011  | 1000 0000 0011     | 0                                     |
| -0.9980469  | 0000 0000 0100  | 1000 0000 0100     | 0                                     |
|             |   |                    | 0                                     |
| -0.0009766  | 0111 1111 1110  | 1111 1111 1110     | 0                                     |
| -0.0004883  | 0111 1111 1111  | 1111 1111 1111     | 0                                     |
| 0.0000000   | 1000 0000 0000  | 0000 0000 0000     | 0                                     |
| +0.0004883  | 1000 0000 0001  | 0000 0000 0001     | 0                                     |
| +0.0009766  | 1000 0000 0010  | 0000 0000 0010     | 0                                     |
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| INP-INM (V) | Offset binary  | Two's complement | OTR |
|-------------|----------------|------------------|-----|
|             |                |                  | 0   |
| +0.9980469  | 1111 1111 1011 | 0111 1111 1011   | 0   |
| +0.9985352  | 1111 1111 1100 | 0111 1111 1100   | 0   |
| +0.9990234  | 1111 1111 1101 | 0111 1111 1101   | 0   |
| +0.9995117  | 1111 1111 1110 | 0111 1111 1110   | 0   |
| +1.0000000  | 1111 1111 1111 | 0111 1111 1111   | 0   |
| > +1        | 1111 1111 1111 | 0111 1111 1111   | 1   |

Table 13. Output codes versus input voltage ... continued

### 14.6 Serial Peripheral Interface (SPI)

### 14.6.1 Register description

The ADC1213D serial interface is a synchronous serial communications port allowing for easy interfacing with many industry microprocessors. It provides access to the registers that control the operation of the chip in both read and write modes.

This interface is configured as a 3-wire type (SDIO as bidirectional pin).

SCLK acts as the serial clock, and  $\overline{CS}$  acts as the serial chip select bar.

Each read/write operation is sequenced by the  $\overline{CS}$  signal and enabled by a LOW level to to drive the chip with 2 bytes to 5 bytes, depending on the content of the instruction byte (see Table 14).

### Table 14. Instruction bytes for the SPI

|             | · · · · · · · · · · · · · · · · · · · |    |    |     |     |     |    |     |
|-------------|---------------------------------------|----|----|-----|-----|-----|----|-----|
|             | MSB                                   |    |    |     |     |     |    | LSB |
| Bit         | 7                                     | 6  | 5  | 4   | 3   | 2   | 1  | 0   |
| Description | R/W[1]                                | W1 | W0 | A12 | A11 | A10 | A9 | A8  |
|             | A7                                    | A6 | A5 | A4  | A3  | A2  | A1 | A0  |

[1] R/W indicates whether a read or write transfer occurs after the instruction byte

### Table 15. Read or Write mode access description

| R/W[1] | Description          |
|--------|----------------------|
| 0      | Write mode operation |
| 1      | Read mode operation  |

[1] Bits W1 and W0 indicate the number of bytes transferred after the instruction byte.

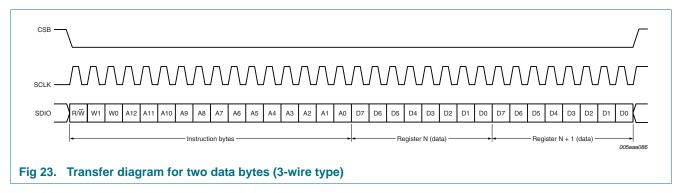
### Table 16. Number of bytes to be transferred

| W1 | WO | Number of bytes             |
|----|----|-----------------------------|
| 0  | 0  | 1 byte transferred          |
| 0  | 1  | 2 bytes transferred         |
| 1  | 0  | 3 bytes transferred         |
| 1  | 1  | 4 or more bytes transferred |

Bits A12 to A0 indicate the address of the register being accessed. In the case of a multiple byte transfer, this address is the first register to be accessed. An address counter is incremented to access subsequent addresses.

The steps involved in a data transfer are as follows:

- 1. The falling edge on  $\overline{CS}$  in combination with a rising edge on SCLK determine the start of communications.
- 2. The first phase is the transfer of the 2-byte instruction.
- 3. The second phase is the transfer of the data which can be vary in length but will always be a multiple of 8 bits. The MSB is always sent first (for instruction and data bytes):



### 14.6.2 Channel control

The two ADC channels can be configured at the same time or separately. By using the register "Channel index", the user can choose which ADC channel will receive the next SPI-instruction. By default the channel A and B will receive the same instructions in write mode. In read mode only A is active.

| 13D   | Addr   | Register name                | R/W <sup>[1]</sup> | Bit definition   |                      |              |                      |                |             |                   |                  |              |  |
|---|--|------------------------------|--------------------|------------------|----------------------|--------------|----------------------|----------------|-------------|-------------------|------------------|--------------|--|
| ADC1213D SER (  | Hex  |                              | Bit 7              | Bit 6            | Bit 5                | Bit 4        | Bit 3                | Bit 2          | Bit 1       | Bit 0             | Bin              |              |  |
| 01  | ADC co   | ontrol register              |                    |                  |                      |              |                      |                |             |                   |                  |              |  |
|   | Table 17. Register allocation map         Addr       Register name<br>Hex       R/W[1]       Bit definition         Bit 7       Bit 6       Bit 5       Bit 4       Bit 3       Bit<br>Bit 7         ADC control register       R/W       R/W       RESERVED[5:0]       -         0005       Reset and       R/W       SW_       RESERVED[2:0]       - |                              |                    |                  |                      |              |                      |                |             | ADCB              | ADCA             | 1111 11      |  |
|   | 0005   | Reset and<br>Operating modes | R/W                | SW_<br>RST       | F                    | RESERVED     | [2:0]                | -              | -           | PD                | [1:0]            | 0000 00      |  |
|   | 0006   | Clock                        | R/W                | -                | -                    | -            | SE_SEL               | DIFF_SE        | -           | CLKDIV2_<br>SEL   | DCS_EN           | 0000<br>000X |  |
|   | 8000   | Vref                         | R/W                | -                | -                    | -            | -                    | INTREF_<br>EN  |             | INTREF[2:0]       | ]                | 0000 00      |  |
|   | 0013   | Offset                       | R/W                | -                | -                    |              |                      | DIG_C          | OFFSET[5:0] |                   |                  | 0000 00      |  |
| Allini  | 0014   | Test pattern 1               | R/W                | -                | -                    | -            | -                    | -              |             | TESTPAT_1[2       | :0]              | 0000 00      |  |
| formati   | 0015   | Test pattern 2               | R/W                |                  |                      |              | TEST                 | PAT_2[13:6]    |             |                   |                  | 0000 00      |  |
| on prov   | 0016   | Test pattern 3               | R/W                |                  | -                    | TESTPAT_3    | [5:0]                |                | -           | -                 | -                | 0000 00      |  |
| rided ir  | JESD2  | 04A control                  |                    |                  |                      |              |                      |                |             |                   |                  |              |  |
| this docum  | 0801   | Ser_Status                   | R                  | RXSYNC_<br>ERROR |                      |              |                      |                |             |                   | RESERVED         | 0000 00      |  |
| ent is subje  | 0802   | Ser_Reset                    | R/W                | SW_<br>RST       | 0                    | 0            | 0                    | FSM_SW_<br>RST | 0           | 0                 | 0                | 0000 00      |  |
| ct to le  | 0803   | Ser_Cfg_Setup                | R/W                | 0                | 0                    | 0            | 0                    |                | CFG         | SETUP[3:0]        |                  | 0000 **      |  |
| All information provided in this document is subject to legal disclaimers | 0805   | Ser_Control1                 | R/W                | 0                | TriState_<br>CFG_PAD | SYNC_<br>POL | SYNC_SING<br>LEENDED | 1              |             | RESERVED[2        | 0100 10          |              |  |
| urs.  | 0806   | Ser_Control2                 | R/W                | 0                | 0                    | 0            | 0                    | 0              | 0           | SWAP_<br>LANE_1_2 | SWAP_<br>ADC_0_1 | 0000 00      |  |
|   | 0808   | Ser_Analog_Ctrl              | R/W                | 0                | 0                    | 0            | 0                    | 0              |             | SWING_SEL[2       | 2:0]             | 0000 00      |  |
|   | 0809   | Ser_ScramblerA               | R/W                | 0                | 0 LSB_INIT[6:0]      |              |                      |                |             |                   |                  | 0000 00      |  |
|   | 080A   | Ser_ScramblerB               | R/W                |                  |                      |              | MSI                  | B_INIT[7:0]    |             |                   |                  | 1111 11      |  |
|   | 080B   | Ser_PRBS_Ctrl                | R/W                | 0                | 0                    | 0            | 0                    | 0              | 0           | PRBS_1            | TYPE[1:0]        | 0000 00      |  |
| 0<br>Z  | 0820   | Cfg_0_DID                    | R/W*               |                  |                      |              |                      | DID[7:0        | ]           |                   |                  | 1110 11      |  |
| © NXP B.V. 2010. All rights reserved                                      | 0821   | Cfg_1_BID                    | R/W*               | 0                | 0                    | 0            | 0                    |                |             | BID[3:0]          |                  | 0000 10      |  |
| 1. 2010   | 0822   | Cfg_3_SCR_L                  | R/W*               | SCR              | 0                    | 0            | 0                    | 0              | 0           | 0                 | L                | *000 00      |  |
| . All ria   | 0823   | Cfg_4_F                      | R/W*               | 0                | 0                    | 0            | 0                    | 0              |             | F[2:0]            |                  | 0000 0*      |  |
| hts res   | 0824   | Cfg_5_K                      | R/W*               | 0                | 0                    | 0            |                      |                | K[4:0]      |                   |                  | 000* ***     |  |
| ervec   | 0825   | Cfg_6_M                      | R/W*               | 0                | 0                    | 0            | 0                    | 0              | 0           | 0                 | М                | 0000 00      |  |

ADC1213D series ADC1213D series

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Default<sup>[2]</sup>

0100 0\*\*\*

0000 1111

0000 0000

\*000 0000

0001 1011

0001 1100

\*\*\*\* \*\*\*\*

\*\*\*\* \*\*\*\*

0000 000\*

0000 000\*

0000 000\*

0000 000\*

Bin

Bit 0

CF[1:0]

S

LANE\_PD

LANE\_PD

ADC\_PD

ADC\_PD

ADC1213D series

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| 0870 | LaneA_0_Ctrl | R/W | 0 | SCR_IN_<br>MODE | LANE_MODE[1:0] |
|------|--------------|-----|---|-----------------|----------------|
| 0871 | LaneB_0_Ctrl | R/W | 0 | SCR_IN_<br>MODE | LANE_MODE[1:0] |
| 0890 | ADCA_0_Ctrl  | R/W | 0 | 0               | ADC_MODE[1:0]  |

R/W<sup>[1]</sup> Bit definition

Bit 7

0

0

0

HD

0

0

R/W\*

R/W\*

R/W\*

R/W\*

R/W\*

R/W

R

Bit 6

CS[0]

0

0

0

0

0

0

 Table 17.
 Register allocation map ...continued

**Register name** 

Cfg\_7\_CS\_N

Cfg\_10\_HD\_CF

Cfg\_01\_2\_LID

Cfg\_02\_2\_LID

ADCB 0 Ctrl

Cfg01\_13\_FCHK R

Cfg02\_13\_FCHK R

Cfg\_8\_Np

Cfg\_9\_S

[1] an "\*" in the Access column means that this register is subject to control access conditions in Write mode.

0

[2] an "\*" in the Default column replaces a bit of which the value depends on the binary level of external pins (e.g. CFG[3:0], Swing[1:0], Scrambler).

ADC\_MODE[1:0]

Bit 4

0

0

0

Bit 5

0

0

0

0

0

0

Bit 3

FCHK[7:0]

FCHK[7:0]

0

0

0

0

0

0

Bit 2

NP[4:0]

0

0

LID[4:0]

LID[4:0]

LANE

POL

LANE

POL

0

0

Bit 1

N[3:0]

0

LANE\_CLK

POS EDGE

LANE\_CLK\_

POS\_EDGE

0

0

Preliminary data sheet ADC1213D\_SER\_5

Addr

Hex

0826 0827

0828

0829

082C

082D

084C

084D

0891

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### 14.6.3 Register description

### 14.6.3.1 ADC control register

| Bit    | Symbol        | Access | Value  | Description                         |
|--------|---------------|--------|--------|-------------------------------------|
| 7 to 2 | RESERVED[5:0] | -      | 111111 | reserved                            |
| 1      | ADCB          | R/W    |        | ADCB will get the next SPI command: |
|        |               |        | 0      | ADCB not selected                   |
|        |               |        | 1      | ADCB selected                       |
| 0      | ADCA          | R/W    |        | ADCA will get the next SPI command: |
|        |               |        | 0      | ADCA not selected                   |
|        |               |        | 1      | ADCA selected                       |

### Table 19. Register reset and Power-down mode (address 0005h)

| Bit    | Symbol        | Access | Value | Description                          |
|--------|---------------|--------|-------|--------------------------------------|
| 7      | SW_RST        | R/W    |       | reset digital part:                  |
|        |               |        | 0     | no reset                             |
|        |               |        | 1     | performs a reset of the digital part |
| 6 to 4 | RESERVED[2:0] | -      | 000   | reserved                             |
| 3 to 2 | -             | -      | 00    | not used                             |
| 1 to 0 | PD[1-0]       | R/W    |       | power-down mode:                     |
|        |               |        | 00    | normal (power-up)                    |
|        |               |        | 01    | full power-down                      |
|        |               |        | 10    | sleep                                |
|        |               |        | 11    | normal (power-up)                    |

### Table 20. Register clock (address 0006h)

| Bit    | Symbol      | Access | Value | Description                                   |
|--------|-------------|--------|-------|---|
| 7 to 5 | -           | -      | 000   | not used                                      |
| 4      | SE_SEL      | R/W    |       | select SE clock input pin:                    |
|        |             |        | 0     | Select CLKM input                             |
|        |             |        | 1     | Select CLKP input                             |
| 3      | DIFF_SE     | R/W    |       | differential/single ended clock input select: |
|        |             |        | 0     | Fully differential                            |
|        |             |        | 1     | Single-ended                                  |
| 2      | -           | -      | 0     | not used                                      |
| 1      | CLKDIV2_SEL | R/W    |       | select clock input divider by 2:              |
|        |             |        | 0     | disable                                       |
|        |             |        | 1     | active  |
| 0      | DCS_EN      | R/W    |       | duty cycle stabilizer enable:                 |
|        |             |        | 0     | disable                                       |
|        |             |        | 1     | active  |

ADC1213D series

| Table 21. | Register | Vref | (address | 0008h) |
|-----------|----------|------|----------|--------|
|-----------|----------|------|----------|--------|

| Bit    | Symbol          | Access | Value | Description                             |
|--------|-----------------|--------|-------|---|
| 7 to 4 | -               | -      | 0000  | not used                                |
| 3      | 3 INTREF_EN R/W |        |       | enable internal programmable VREF mode: |
|        |                 |        | 0     | disable                                 |
|        |                 |        | 1     | active                                  |
| 2 to 0 | INTREF[2:0]     | R/W    |       | programmable internal reference:        |
|        |                 |        | 000   | 0 dB (FS=2 V)                           |
|        |                 |        | 001   | –1 dB (FS=1.78 V)                       |
|        |                 |        | 010   | -2 dB (FS=1.59 V)                       |
|        |                 |        | 011   | -3 dB (FS=1.42 V)                       |
|        |                 |        | 100   | -4 dB (FS=1.26 V)                       |
|        |                 |        | 101   | –5 dB (FS=1.12 V)                       |
|        |                 |        | 110   | 6 dB (FS=1 V)                           |
|        |                 |        | 111   | not used                                |

### Table 22. Digital offset adjustment (address 0013h)

| Register offset: (address 0013h) |                 |                 |  |  |  |  |  |
|----------------------------------|-----------------|-----------------|--|--|--|--|--|
| Decimal                          | DIG_OFFSET[5:0] | DIG_OFFSET[5:0] |  |  |  |  |  |
| +31                              | 011111          | +31 LSB         |  |  |  |  |  |
|                                  |                 |                 |  |  |  |  |  |
| 0                                | 000000          | 0               |  |  |  |  |  |
|                                  |                 |                 |  |  |  |  |  |
| -32                              | 100000          | -32 LSB         |  |  |  |  |  |

### Table 23. Register test pattern 1 (address 0014h)

|                       | •      |        |       |  |
|-----------------------|--------|--------|-------|--|
| Bit                   | Symbol | Access | Value | Description  |
| 7 to 3                | -      | -      | 00000 | not used   |
| 2 to 0 TESTPAT_1[2:0] |        | R/W    |       | digital test pattern:  |
|                       |        |        | 000   | off  |
|                       |        |        | 001   | mid-scale  |
|                       |        |        | 010   | – FS   |
|                       |        |        | 011   | + FS   |
|                       |        |        | 100   | toggle '11111111'/'00000000'                                   |
|                       |        |        | 101   | custom test pattern, to be written in register 0015h and 0016h |
|                       |        |        | 110   | ʻ010101'   |
|                       |        |        | 111   | '101010'   |

### Table 24. Register test pattern 2 (address 0015h)

| Bit    | Symbol          | Access | Value   | Description                               |
|--------|-----------------|--------|---------|---|
| 7 to 0 | TESTPAT_2[13:6] | R/W    | 0000000 | custom digital test pattern (bit 13 to 6) |

### Table 25. Register test pattern 3 (address 0016h)

| Bit    | Symbol         | Access | Value | Description                              |
|--------|----------------|--------|-------|--|
| 7 to 3 | TESTPAT_3[5:0] | R/W    | 00000 | custom digital test pattern (bit 5 to 0) |
| 2 to 0 | -              | -      | 000   | not used                                 |

### 14.6.4 JESD204A digital control registers

| Bit Symbol Access Value Description                  |                  |
|--|------------------|
|  |                  |
| 7 RXSYNC_ERROR R/W 0 set to 1 when a synchronization | ion error occurs |
| 6 to 4 RESERVED[2:0] - 010 reserved                  |                  |
| 3 to 2 0 not used                                    |                  |
| 1 POR_TST R 1 power-on-reset                         |                  |
| 0 RESERVED reserved                                  |                  |

### Table 27. SER reset (address 0802h)

| Bit    | Symbol     | Access | Value | Description  |
|--------|------------|--------|-------|--|
| 7      | SW_RST     | R/W    | 0     | initiates a software reset of the JEDEC204A unit                           |
| 6 to 4 | -          | -      | 000   | not used   |
| 3      | FSM_SW_RST | R/W    | 0     | initiates a software reset of the internal state machine of JEDEC204A unit |
| 2 to 0 | -          | -      | 000   | not used   |

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| Bit    | Symbol         | Access | Value           | Description   |
|--------|----------------|--------|-----------------|---|
| 7 to 4 | -              | R      | 0000            | not used  |
| 3 to 0 | CFG_SETUP[3:0] | R/W    | 0000<br>(reset) | defines quick JESD204A configuration. These settings overrule the CFG_PAD configuration                             |
|        |                |        | 0000            | ADC0: ON; ADC1: ON; Lane0: ON; Lane1: ON; F = 2; HD = 0; K = 9; M = 2; L = $2^{2}$                                  |
|        |                |        | 0001            | ADC0: ON; ADC1: ON; Lane0: ON; Lane1: OFF; F = 4; HD = 0; K = 5; M = 2; L = 1 <sup>[2]</sup>                        |
|        |                |        | 0010            | ADC0: ON; ADC1: ON; Lane0: OFF <sup>[2]</sup>   |
|        |                |        | 0011            | ADC0: ON; ADC1: OFF; Lane0: ON; Lane1: ON; F = 1; HD = 1; K = 17; $M = 1$ ; L = 2 <sup>[2]</sup>                    |
|        |                |        | 0100            | ADC0: OFF; ADC1: ON; Lane0: ON; Lane1: ON; F = 1; HD = 1; K = 17;<br>M = 1; L = 2; SWAP_ADC_0_1 = 1 <sup>[2]</sup>  |
|        |                |        | 0101            | ADC0: ON; ADC1: OFF; Lane0: ON; Lane1: OFF; F = 2; HD = 0; K = 9; M = 1; L = $1^{2}$                                |
|        |                |        | 0110            | ADC0: ON; ADC1: OFF; Lane0: OFF; Lane1: ON; F = 2; HD = 0; K = 9; M = 1; L = 1; SWAP_LANE_1_2 = 1 <sup>[2]</sup>    |
|        |                |        | 0111            | ADC0: OFF; ADC1: ON; Lane0: ON; Lane1: OFF; F = 2; HD = 0; K = 9;<br>M = 1; L = 1; SWAP_ADC_0_1 = 1 <sup>[2]</sup>  |
|        |                |        | 1000            | ADC0: OFF; ADC1: ON; Lane0: OFF; Lane1: ON; F = 2; HD = 0; K = 9;<br>M = 1; L = 1; SWAP_ADC_0_1 <sup>[2]</sup>      |
|        |                |        | 1001 to<br>1101 | reserved  |
|        |                |        | 1110            | ADC0: OFF; ADC1: OFF; Lane0: ON; Lane1: ON; F = 2; HD = 0; K = 9; M = 2; L = 2; loop alignment = $1^{\boxed{2}}$    |
|        |                |        | 1111            | ADC0: OFF; ADC1: OFF; Lane0: OFF; Lane1: OFF; F = 2; HD = 0;<br>K = 9; M = 2; L = 2 $\rightarrow$ PD <sup>[2]</sup> |

### Table 28. SER cfg set-up (address 0803h)[1]

[1] The default value for this register depends on the external pull-up/pull-down on CFG0, CFG1, CFG2 or CFG3. Writing to the register overwrites this value.

[2] F: number of byte per frame; HD: High density; K: number of frames per multi frame; M: number of converters; L: number of lanes

See the information about the JESD204A standard on the JEDEC web site.

### Table 29. SER control1 (address 0805h)

| Bit | Symbol            | Access | Value | Description   |
|-----|-------------------|--------|-------|---|
| 7   |                   | R      | 0     | not used  |
| 6   | TRISTATE_CFG_PAD  | R/W    | 1     | CFG pads (3 to 0) are set to high-impedance. Switch to 0 automatically after start-up or reset. |
| 5   | 5 SYNC_POL        | R/W    |       | defines the sync signal polarity:   |
|     |                   |        | 0     | synchronization signal is active low  |
|     |                   |        | 1     | synchronization signal is active high   |
| 4   | SYNC_SINGLE_ENDED | R/W    |       | defines the input mode of the sync signal:  |
|     |                   |        | 0     | synchronization input mode is set in Differential mode  |
|     |                   |        | 1     | synchronization input mode is set in Single-ended mode  |
| 3   | -                 | R      | 1     | not used  |

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| Table 2      | Table 29.         SER control1 (address 0805h)continued |        |       |  |  |  |  |
|--------------|---|--------|-------|--|--|--|--|
| Bit          | Symbol  | Access | Value | Description  |  |  |  |
| 2            | REV_SCR   | -      |       | enables swapping bits at the scrambler input                 |  |  |  |
|              |   |        | 0     |  |  |  |  |
|              |   |        | 1     | LSB are swapped to MSB at the scrambler input                |  |  |  |
| 1            | REV_ENCODER   | -      |       | enables swapping bits at the 8b/10b encoder input:           |  |  |  |
|              |   |        | 0     |  |  |  |  |
|              |   |        | 1     | LSB are swapped to MSB at the 8b/10b encoder input           |  |  |  |
| 0 REV_SERIAL | REV_SERIAL  | -      |       | enables swapping bits at the lane input (before serializer): |  |  |  |
|              |   |        | 0     |  |  |  |  |
|              |   |        | 1     | LSB are swapped to MSB at the lane input                     |  |  |  |

### Table 30. SER control2 (address 0806h)

| Bit             | Symbol        | Access | Value  | Description  |
|-----------------|---------------|--------|--------|--|
| 7 to 2          | -             | R      | 000000 | not used   |
| 1 SWAP_LANE_1_2 | SWAP_LANE_1_2 | R/W    |        | controls the JESD204A output multiplexer:  |
|                 |               |        | 0      |  |
|                 |               |        | 1      | outputs of the JESD204A unit are swapped. (Output0 is connected to Lane1, Output1 is connected to Lane0)   |
| 0               | SWAP_ADC_0_1  | R/W    |        | controls the JESD204A input multiplexer:   |
|                 |               |        | 0      |  |
|                 |               |        | 1      | inputs of the JESD204A unit are swapped. (ADC0 output is connected to Input1, ADC1 is connected to Input0) |

### Table 31. SER analog ctrl (address 0808h)

| Bit    | Symbol         | Access | Value | Description                                |
|--------|----------------|--------|-------|--|
| 7 to 3 | -              | R      | 00000 | not used                                   |
| 2 to 0 | SWING_SEL[2:0] | R/W    | 0**   | defines the swing output for the lane pads |

### Table 32. SER scramblerA (address 0809h)

| Bit    | Symbol        | Access | Value   | Description  |
|--------|---------------|--------|---------|--|
| 7      | -             | R      | 0       | not used   |
| 6 to 0 | LSB_INIT[6:0] | R/W    | 0000000 | defines the initialization vector for the scrambler polynomial (lower) |

### Table 33. SER scramblerB (address 080Ah)

| Bit    | Symbol        | Access | Value    | Description  |
|--------|---------------|--------|----------|--|
| 7 to 0 | MSB_INIT[7:0] | R/W    | 11111111 | defines the initialization vector for the scrambler polynomial (upper) |

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### Table 34. SER PRBS Ctrl (address 080Bh)

| Bit    | Symbol         | Access | Value      | Description  |
|--------|----------------|--------|------------|--|
| 7 to 2 | -              | R      | 000000     | not used   |
| 1 to 0 | PRBS_TYPE[1:0] | R/W    |            | defines the type of Pseudo-Random Binary Sequence (PRBS) generator to be used: |
|        |                |        | 00 (reset) | PRBS-7   |
|        |                |        | 01         | PRBS-7   |
|        |                |        | 10         | PRBS-23  |
|        |                |        | 11         | PRBS-31  |

### Table 35. Cfg\_0\_DID (address 0820h)

| Bit    | Symbol   | Access | Value    | Description                                       |
|--------|----------|--------|----------|---|
| 7 to 0 | DID[7:0] | R      | 11101101 | defines the device (= link) identification number |

### Table 36. Cfg\_1\_BID (address 0821h)

| Bit    | Symbol   | Access | Value | Description                            |
|--------|----------|--------|-------|--|
| 7 to 4 | -        | R      | 0000  | not used                               |
| 3 to 0 | BID[3:0] | R/W    | 1010  | defines the bank ID – extension to DID |

### Table 37. Cfg\_3\_SCR\_L (address 0822h)

| Bit    | Symbol | Access | Value  | Description   |
|--------|--------|--------|--------|---|
| 7      | SCR    | R/W    | *      | scrambling enabled  |
| 6 to 1 | -      | R      | 000000 | not used  |
| 0      | L      | R/W    | *      | defines the number of lanes per converter device, minus 1 |

### Table 38. Cfg\_4\_F (address 0823h)

| Bit    | Symbol | Access | Value | Description                                     |
|--------|--------|--------|-------|---|
| 7 to 3 | -      | R      | 00000 | not used  |
| 2 to 0 | F[2:0] | R/W    | ***   | defines the number of octets per frame, minus 1 |

### Table 39. Cfg\_5\_K (address 0824h)

| Bit    | Symbol | Access | Value | Description  |
|--------|--------|--------|-------|--|
| 7 to 5 | -      | R      | 000   | not used   |
| 4 to 0 | K[4:0] | R/W    | ****  | defines the number of frames per multiframe, minus 1 |

### Table 40. Cfg\_6\_M (address 0825h)

| Bit    | Symbol | Access | Value   | Description  |
|--------|--------|--------|---------|--|
| 7 to 1 | -      | R      | 0000000 | not used   |
| 0      | Μ      | R/W    | *       | defines the number of converters per device, minus 1 |

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| Bit                  | Symbol                 | Access      | Value   | Description  |
|----------------------|------------------------|-------------|---------|--|
| 7                    | -                      | R           | 0       | not used   |
| 6                    | CS[0]                  | R/W         | *       | defines the number of control bits per sample, minus 1   |
| 5 to 4               | -                      | R           | 00      | not used   |
| 3 to 0               | N[3:0]                 | R/W         | ****    | defines the converter resolution   |
|                      |                        |             |         |  |
|                      | 42. Cfg_8_Np (address  |             |         |  |
| Bit                  | Symbol                 | Access      | Value   | Description  |
| 7 to 5               | -                      | R           | 000     | not used   |
| 4 to 0               | NP[4:0]                | R/W         | ****    | defines the total number of bits per sample, minus 1   |
| Table /              | 43. Cfg_9_S (address ( | 18284)      |         |  |
| Bit                  | Symbol                 | Access      | Value   | Description  |
| 7 to 1               | -                      | R           | 0000000 | not used   |
| 0                    | S                      | R/W         | 1       | defines number of samples per converter per frame cycle  |
| -                    | -                      | •           | -       |  |
| Table 4              | 44. Cfg_10_HD_CF (ad   | dress 0829  | h)      |  |
| Bit                  | Symbol                 | Access      | Value   | Description  |
| 7                    | HD                     | R/W         | *       | defines high density format  |
| 6 to 2               | -                      | R           | 00000   | not used   |
| 1 to 0               | CF[1:0]                | R/W         | **      | defines number of control words per frame clock cycle per link   |
|                      |                        |             |         |  |
| Table 4              | 45. Cfg01_2_LID (addro | ess 082Ch)  |         |  |
| Bit                  | Symbol                 | Access      | Value   | Description  |
| 7 to 5               | -                      | R           | 000     | not used   |
| 4 to 0               | LID[4:0]               | R/W         | 11011   | defines lane1 identification number  |
| Table                |                        |             |         |  |
|                      | - · ·                  |             | Value   | Description  |
| Bit                  | Symbol                 | Access      | Value   | Description  |
| 7 to 5               | -                      | R           | 000     | not used   |
| 4 to 0               | LID[4:0]               | R/W         | 11100   | defines lane2 identification number  |
| Table 4              | 47. Cfg02_13_fchk (add | dress 084Cl | h)      |  |
|                      | Symbol                 | Access      | Value   | Description  |
| Bit                  | -                      | R           | ******  | defines the checksum value for lane1   |
| <b>Bit</b><br>7 to 0 | FCHK[7:0]              |             |         |  |
| Bit<br>7 to 0        | FCHK[7:0]              |             |         | checksum corresponds to the sum of all the link configuration  |
|                      | FCHK[7:0]              |             |         | checksum corresponds to the sum of all the link configuration<br>parameters modulo 256 (as defined in JEDEC Standard<br>No.204A) |

Table 48. Cfg01\_13\_fchk (address 084Dh)

# **ADC1213D series**

| Bit     | Symbol                  | Access    | Value             | Description   |
|---------|-------------------------|-----------|-------------------|---|
| 7 to 0  | FCHK[7:0]               | R         | ******            | defines the checksum value for lane1  |
|         |                         |           |                   | checksum corresponds to the sum of all the link configuration parameters module 256 (as defined in JEDEC Standard No.204A)                |
| Table 4 | 9. LaneA_0_ctrl (addres | ss 0870h) |                   |   |
| Bit     | Symbol                  | Access    | Value             | Description   |
| 7       | -                       | R         | 0                 | not used  |
| 6       | SCR_IN_MODE             | R/W       |                   | defines the input type for scrambler and 8-bit/10-bit units:  |
|         |                         |           | <b>0</b> (reset)  | (normal mode) = Input of the scrambler and 8-bit/10-bit units is the output of the frame assembly unit.                                   |
|         |                         |           | 1                 | input of the scrambler and 8-bit/10-bit units is the PRSB<br>generator (PRBS type is defined with "PRBS_TYPE"<br>(Ser_PRBS_ctrl register) |
| 5 to 4  | LANE_MODE[1:0]          | R/W       |                   | defines output type of Lane output unit:  |
|         |                         |           | <b>00</b> (reset) | normal mode: Lane output is the 8-bit/10-bit output unit  |
|         |                         |           | 01                | constant mode: Lane output is set to a constant (0 $\times$ 0)  |
|         |                         |           | 10                | toggle mode: Lane output is toggling between $0\times 0$ and $0\times 1$  |
|         |                         |           | 11                | PRBS mode: Lane output is the PRBS generator (PRBS type is defined with "PRBS_TYPE" (Ser_PRBS_ctrl register)                              |
| 3       | -                       | R         | 0                 | not used  |
| 2       | LANE_POL                | R/W       |                   | defines lane polarity:  |
|         |                         |           | 0                 | lane polarity is normal   |
|         |                         |           | 1                 | lane polarity is inverted   |
| 1       | LANE_CLK_POS_EDGE       | R/W       |                   | defines lane clock polarity:  |
|         |                         |           | 0                 | lane clock provided to the serializer is active on positive edge  |
|         |                         |           | 1                 | lane clock provided to the serializer is active on negative edge  |
| 0       | Lane_PD                 | R/W       |                   | lane power-down control:  |
|         |                         |           | 0                 | lane is operational   |
|         |                         |           | 1                 | lane is in Power-down mode  |

### Table 50. LaneB\_0\_ctrl (address 0871h)

| Bit | Symbol      | Access           | Value   | Description   |
|-----|-------------|------------------|---|---|
| 7   | -           | R                | 0   | not used  |
| 6   | SCR_IN_MODE | R/W              |   | defines the input type for scrambler and 8b/10b units:  |
|     |             | <b>0</b> (reset) | (normal mode) = Input of the scrambler and 8b/10b units is the output of the Frame Assembly unit. |   |
|     |             |                  | 1   | input of the scrambler and 8b/10b units is the PRBS generator<br>(PRBS type is defined with "PRBS_TYPE" (Ser_PRBS_ctrl<br>register) |

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| Bit    | Symbol            | Access | Value      | Description  |
|--------|-------------------|--------|------------|--|
| 5 to 4 | LANE_MODE[1:0]    | R/W    |            | defines output type of lane output unit:   |
|        |                   |        | 00 (reset) | normal mode: Lane output is the 8b/10b output unit   |
|        |                   |        | 01         | constant mode: Lane output is set to a constant (0x0)  |
|        |                   |        | 10         | toggle mode: Lane output is toggling between 0x0 and 0x1   |
|        |                   |        | 11         | PRBS mode: Lane output is the PRSB generator (PRBS type is defined with "PRBS_TYPE" (Ser_PRBS_ctrl register) |
| 3      | -                 | R      | 0          | not used   |
| 2      | LANE_POL          | R/W    |            | defines lane polarity:   |
|        |                   |        | 0          | lane polarity is normal  |
|        |                   |        | 1          | lane polarity is inverted  |
| 1      | LANE_CLK_POS_EDGE | R/W    |            | defines lane clock polarity:   |
|        |                   |        | 0          | lane clock provided to the serializer is active on positive edge   |
|        |                   |        | 1          | lane clock provided to the serializer is active on negative edge   |
| 0      | Lane_PD           | R/W    |            | lane power-down control:   |
|        |                   |        | 0          | lane is operational  |
|        |                   |        | 1          | lane is in Power-down mode   |

### Table 50. LaneB\_0\_ctrl (address 0871h) ... continued

### Table 51. ADCA\_0\_ctrl (address 0890h)

| Bit    | Symbol        | Access | Value      | Description   |
|--------|---------------|--------|------------|---|
| 7 to 6 | -             | R      | 00         | not used  |
| 5 to 4 | ADC_MODE[1:0] | R/W    |            | defines input type of JESD204A unit:  |
|        |               |        | 00 (reset) | ADC output is connected to the JESD204A input   |
|        |               |        | 01         | not used  |
|        |               |        | 10         | JESD204A input is fed with a dummy constant, set to: OTR = 0 and ADC[11:0] = "100110111010"           |
|        |               |        | 11         | JESD204A is fed with a PRBS generator (PRBS type is defined with "PRBS_TYPE" (Ser_PRBS_ctrl register) |
| 3 to 1 | -             | R      | 000        | not used  |
| 0      | ADC_PD        | R/W    |            | ADC power-down control:   |
|        |               |        | 0          | ADC is operational  |
|        |               |        | 1          | ADC is in Power-down mode   |

### Table 52. ADCB\_0\_ctrl (address 0891h)

|           | ,               |        |                        |   |
|-----------|-----------------|--------|------------------------|---|
| Bit       | Symbol          | Access | Value                  | Description   |
| 7 to 6    | -               | R      | 00                     | not used  |
| 5 to 4    | ADC_MODE[1:0]   | R/W    |                        | defines input type of JESD204A unit   |
|           |                 |        | 00 (reset)             | ADC output is connected to the JESD204A input   |
|           |                 |        | 01                     | not used  |
|           |                 |        | 10                     | JESD204A input is fed with a dummy constant, set to: OTR = 0 and ADC[11:0] = "100110111010"           |
|           |                 |        | 11                     | JESD204A is fed with a PRBS generator (PRBS type is defined with "PRBS_TYPE" (Ser_PRBS_ctrl register) |
| 3 to 1    | -               | R      | 000                    | not used  |
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| Prelimir  | nary data sheet |        | Rev. 0                 | 05 — 23 April 2010 35 of 4  |

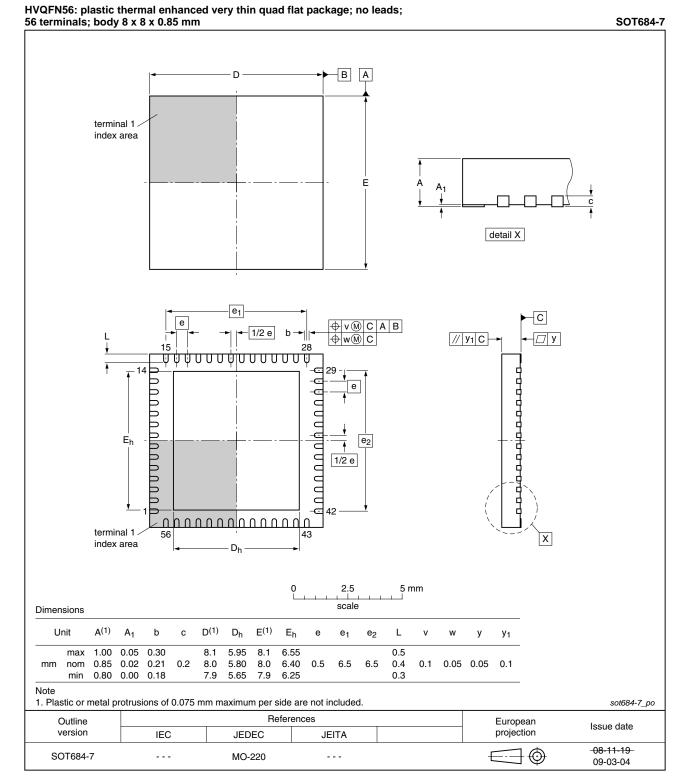
| Bit | Symbol | Access | Value | Description               |
|-----|--------|--------|-------|---------------------------|
| 0   | ADC_PD | R/W    |       | ADC power-down control:   |
|     |        |        | 0     | ADC is operational        |
|     |        |        | 1     | ADC is in Power-down mode |

### Table 52. ADCB\_0\_ctrl (address 0891h) ... continued

# **ADC1213D series**

**ADC1213D series** 

### 15. Package outline



### Fig 24. Package outline SOT684-7 (HVQFN56)

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## 16. Revision history

| Table 53.         Revision history |                                  |                           |                  |                           |
|------------------------------------|----------------------------------|---------------------------|------------------|---------------------------|
| Document ID                        | Release date                     | Data sheet status         | Change<br>notice | Supersedes                |
| ADC1213D_SER_5                     | 20100423                         | Preliminary data sheet    | -                | ADC1213D_SER_4            |
| Modifications:                     | <ul> <li>Product stat</li> </ul> | tus changed from Objectiv | e to Prelim      | inary                     |
| ADC1213D_SER_4                     | 20100412                         | Objective data sheet      | -                | ADC1213D065_080_105_125_3 |
| ADC1213D065_080_105_125_3          | 20090617                         | Objective data sheet      | -                | ADC1213D065_080_105_125_2 |
| ADC1213D065_080_105_125_2          | 20090604                         | Objective data sheet      | -                | ADC1213D065_080_105_125_1 |
| ADC1213D065_080_105_125_1          | 20090528                         | Objective data sheet      | -                | -                         |
|                                    |                                  |                           |                  |                           |

### 17. Legal information

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| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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# **ADC1213D series**

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Date of release: 23 April 2010 Document identifier: ADC1213D\_SER\_5